

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Mitsuru Naito	02/23/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	THE YOKOHAMA RUBBER CO., LTD.
<b>Street Address:</b>	36-11, Shimbashi 5-chome,
<b>Internal Address:</b>	Minato-ku,
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	1058685
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	12406622
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<b>ATTORNEY DOCKET NUMBER:</b>	4386.83824
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<b>Total Attachments: 2</b> source=83824-Assignment#page1.tif source=83824-Assignment#page2.tif	

CH \$40.00 12406622

GREER, BURNS & CRAIN, LTD.  
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Suite 2500  
Chicago, Illinois 60606

## UTILITY PATENT

## ASSIGNMENT

FOR VALUE RECEIVED, the receipt of which is hereby acknowledged, the following inventor or inventors (hereinafter called "ASSIGNOR")

Name: NAITO, Mitsuru  
Address: c/o The Yokohama Rubber Co., Ltd.,  
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Kanagawa 2548601 Japan

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hereby assigns, transfers and sets over to:

Name: THE YOKOHAMA RUBBER CO., LTD.  
Address: 36-11, Shimbashi 5-chome, Minato-ku, Tokyo 1058685 Japan

(hereinafter called "ASSIGNEE"), the entire worldwide right, title and interest in and to the invention known as: TIRE PUNCTURE REPAIR DEVICE

for which a United States Patent Application was executed on even date herewith or, if not so executed, was:

- (a) executed on \_\_\_\_\_; or
- (b) filed on \_\_\_\_\_,  
Serial No. \_\_\_\_/\_\_\_\_\_;

and all rights and privileges under any Letters Patent which may be granted thereon, including all rights, if any, to sue for past infringement.

(1) The ASSIGNOR agrees without charge to said ASSIGNEE but at its expense (a) to execute (i) all necessary papers to be used in connection with this application and any additional, continuing, or divisional applications, as the ASSIGNEE may deem necessary or expedient, (ii)

all papers in connection with any interference or other legal or quasi-legal proceedings relating to this application or any additional, continuing, or divisional application thereof; (b) to cooperate with ASSIGNEE in every way possible in obtaining evidence and going forward in any such proceedings; and (c) to perform all other affirmative acts which may be necessary or desirable to obtain a grant of a valid patent for said invention.

(2) ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States to issue any and all Letters Patent that may be granted upon any patent application or any additional, continuing or divisional applications thereof to the ASSIGNEE, its successors and assigns.

(3) ASSIGNOR hereby covenants and warrants that he has full right to convey the entire right, title and interest by this instrument, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

(4) ASSIGNOR hereby grants to the law firm of GREER, BURNS & CRAIN, LTD. of Chicago, Illinois, authority and power to insert on this instrument any further identification which may be necessary or desirable for purposes of recordation in the United States Patent and Trademark Office or a Patent Office of any foreign country.

Date Feb. 23, 2009

Signature of inventor   
NAITO, Mitsuru

Date \_\_\_\_\_

Signature of inventor \_\_\_\_\_

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Signature of inventor \_\_\_\_\_

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